



# Wide Band Gap Semiconductors – the future of power electronics (based on PECTA – the Power Electronic Conversion Annex of the IEA TCP 4E)

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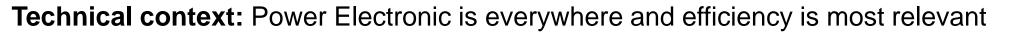
iea-4e.org

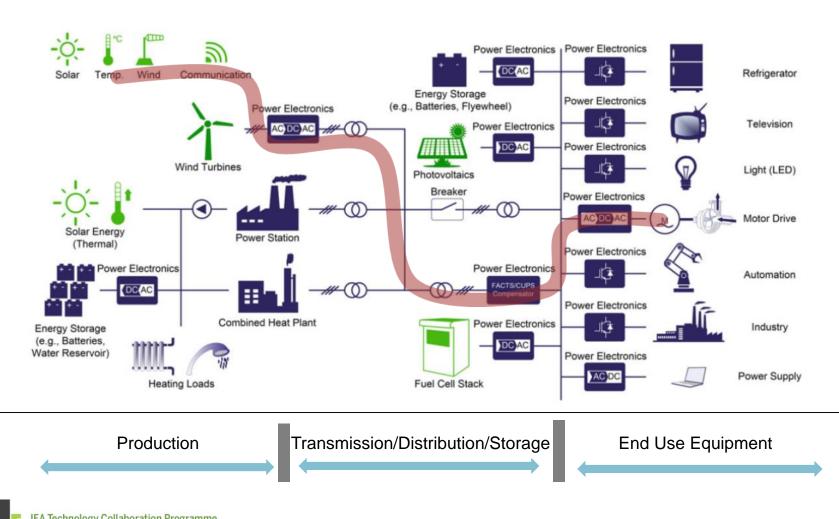


# International Context (IEA-TCP)

- 4E: Energy Efficient End-Use Equipment
- **14 Countries and the EU-Commission** are currently member of the 4E TCP (Countries: AU, AT, CA, CN, DK, FR, JP, KR, NL, NZ, CH, SE, UK, US)
- 4 ongoing Annexes:
  - EMSA: Electric Motor Systems Annex
  - EDNA: Electronic Devices and Networks Annex
  - SSL: Solid State Lighting Annex
  - PECTA: Power Electronic Conversion Technology Annex
- 2 major initiatives:
  - PEET: Product Energy Efficiency Trends
  - cda: Connected Device Alliance
- Link: <u>https://www.iea-4e.org/</u>







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Publication

Wide Band Gap Technology: Efficiency Potential and Application Readiness Map Officially released: May 2020, 100 pages

#### Outline

- o Introduction
- Applications in Focus
- o Advantages of WBG in the Applications
- Existing Roadmaps
- Application Readiness Map
- WBG-Technology Challenges
- Potential Energy Savings for Selected Applications
- Exploring Policies for WBG Technology
- Key Findings and Outlook



Wide Band Gap Technology: Efficiency Potential and Application Readiness Map 4E Power Electronic Conversion Technology Annex (PECTA)

May 2020

echnology Collaboration Programme ytea

https://www.aramis.admin.ch/Default?DocumentID=65690&Load=true

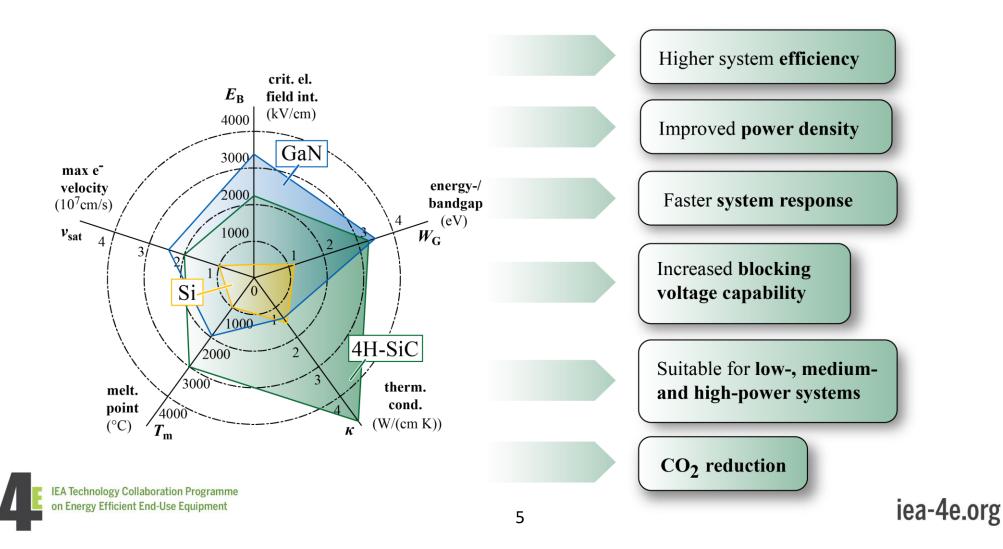






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• Wide Bandgap – An Overview (SiC- and GaN-based semiconductors)



# PECTA, The Power Electronic Conversion Technology Annex



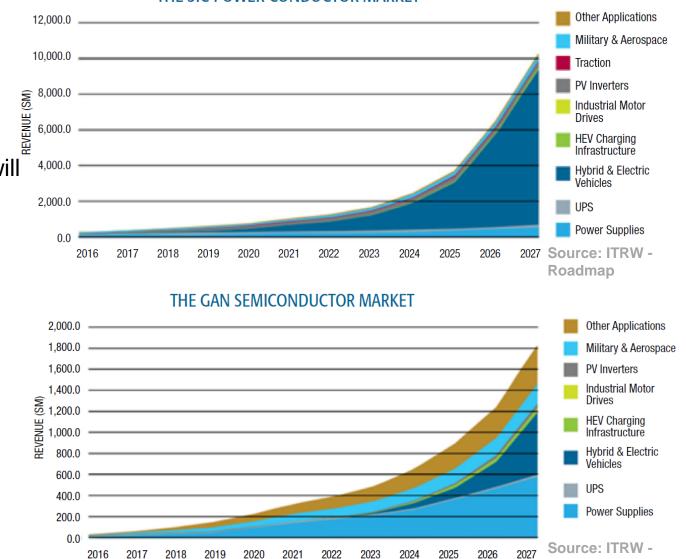
Roadmap

iea-4e.org

#### **PECTA – available results**

- Market prediction SiC:
  - Compound annual growth rate (CAGR) 31% - (2018-2023)
  - According to Yole: Transistors will be key drivers
  - Automotive main driver for SiC Market (traction inverters, onboard chargers, charging infrastructure,...)
- Market prediction GaN:
  - CAGR 55% (2018-2023)
  - Power supplies are shortterm drivers
  - Long-term: EVs, motor drives, wireless charging,...

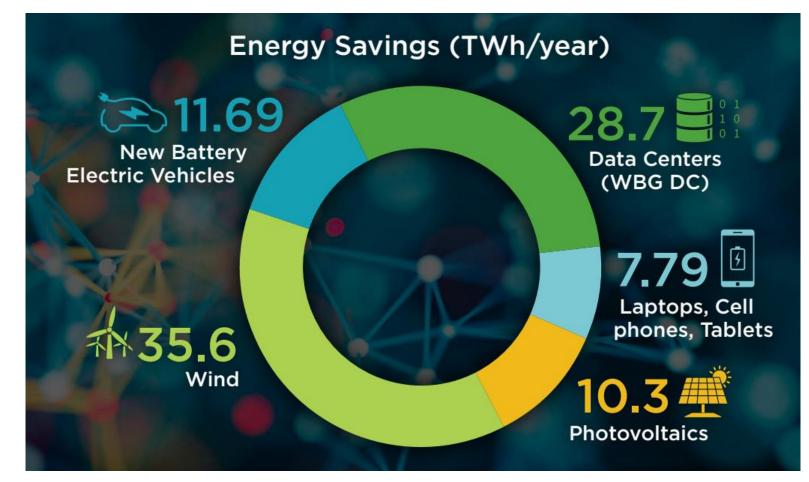
IEA Technology Collaboration Programme on Energy Efficient End-Use Equipment



THE SIC POWER CONDUCTOR MARKET



• Energy Savings of selected applications



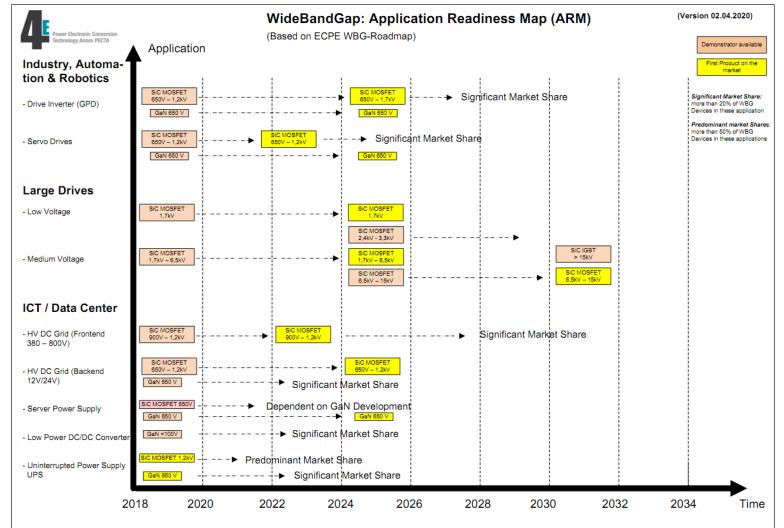


# 4E PECTA, The Power Electronic Conversion Technology Annex



## **PECTA – available results**

- Application Readiness Map (ARM)
- This ARM was as well the basis for an ARM in the HST-TCP
- → Indirect interaction between TCPS via CH-Representative





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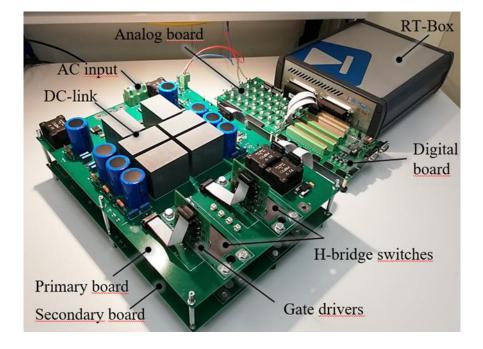
- Policy
- $_{\odot}~$  Listing of different types and sub-types of instruments
- $_{\odot}~$  WBG still at a very early stage for many applications (currently RD&D

Main Type		Sub Type 1		Sub type 2		Main Type		Sub Type 1		Sub type 2	
Economic Instrument	E	Direct investment	D -	Funds to sub-national governments	F	Policy support	Р	Institution creation	I		
				Infrastructure investments	1			Strategic planning	S		
				Procurement rules	Р			Auditing	Α		
				RD&D Funding	R	Regulatory instruments	R	Codes & standards	С	Building codes & standards	В
		Fiscal/Financial incentives	F -	Feed-in tariffs/premiums	F					Product standards	Р
				Grants and subsidies	G					Sectoral standards	S
				Loans	L					Vehicle fuel economy & emissions standards	V
				Tax relief	Tr			Monitoring	М		
				Taxes	Т			Obligation schemes	Ob		
				User charges	С			Other mandatory requirements	0		
		Market-based instruments	М	GHG emissions allowances	Α	Research, devel- opment & de- ployment (RD&D)	RD	Demonstration project	D		
				Green certificates	G			Research program	R	Technology deployment and diffusion	Dp
				White certificates	W					Technology development	Dv
Information & education		Implementation advice/Aid	А			Voluntary approaches	V	Negotiated agreements (Pub- lic-private sector)	N		
		Information provision	I								
		Performance label	L	Comparison label	С			Public voluntary schemes	V	-	
				Endorsement label	E			Unilateral commitments	С		
		Professional training & qualification	Т			IEA 4E EDNA Annex: "Encouraging Intelligent Efficiency - Study of policy opportunities", 2					





- WBG-technology challenges ( = hurdles)
  - Temperature increase
  - Gate voltage limits (particular GaN)
  - o Reliability
  - High switching frequency
  - $\circ~$  New packages and topology solutions
  - o Cost
  - Shortage of materials (particular SiC)
  - o Wafer diameter
  - Standardization (Comparability)





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# PECTAs' goal and ongoing activities (2020 – 2024)

**PECTA goals:** Collecting and analyzing information about new wide band gap (WBG) based power electronic devices;

Coordinating of international approaches that promote WBG-based power electronics Developing greater understanding and action amongst governments and policy makers.

Tasks:Task A: Completing and updating available efficiency figuresTask B: Energy and environmental related life cycle assessment (LCA)Task C: Revision of elaborated application readiness maps (ARMs)Task D: Policy measures and mapping with applications on a timelineTask E: Standards to support the WBG-market entranceTask F: Measurement of power supply efficiency





# GaN-based Power Electronics for Energy Efficiency Applications

EPFL, Completion Q1 2019 (<u>https://www.aramis.admin.ch/Texte/?ProjectID=36837</u>) Investigating the increase of system efficiency in power conversion by using GaN semiconductor technology

# High-efficiency power converters for potentially-large energy-savings applications

**EPFL**, Completion Q2 2020 (<u>https://www.aramis.admin.ch/Texte/?ProjectID=40293</u>) Design and demonstration of power converter circuits with large energy saving potential for demanding applications such as PV microinverters and LED-based street lighting

#### Advanced SiC Material for Power Electronic Devices (Ampere)

FHNW / HITACHI-ENERGY, Completion Q3 2021 (<u>https://www.aramis.admin.ch/Texte/?ProjectID=40193</u>)

Development of advanced high voltage SiC device technologies that go beyond the state of the art. The focus was on 6.5 and 10 kV SiC switches and diodes.

#### Roadrunner Commercial Vehicle Inverter and Testing on eBus Line

ABB / RVBW / FHNW, Completion 2022 / 2023 (extension)

As part of the P+D project "Roadrunner", a fleet of eBuses was to be equipped with a new power converter based on Silicon Carbide (SiC) semiconductors;





### Swiss Hybrid Inverter

## FHNW, Completion Q3 2022

Simulation, construction and measurement of a prototype Si IGBT/SiC MOSFET cross-hybrid-switch with 1,2 kV and 100 kW

## IEA PECTA: Analysis and Loss Measurements of WBG-based Devices EPFL, Completion Q2 2024

Development of basics for WBG devices as a basis for future reproducible measurements (prerequisite for standardization)

#### **Optimized SiC PV-Converter**

# ZHAW / AIT, Completion Q4 2023 / Q1 2024

Construction of a PV inverter in the power range of 5-10kW based on a SiC MOSFET bridge from Infineon and comparison with a commercial Si-based PV inverter

#### Optimal, application-relevant and system efficiency of SiC-pump-drive

FHNW, Grundfos Pumpen AG, Completion Q 2025 Development of efficient SiC converter in the range of several kW for water pumps (or water circulated pump)





# PECTA, The Power Electronic Conversion Technology Annex

# Contacts

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AC Side Filter DC Capacitors Control Board CM Filter (DC Side) OC Inductor



